

1 General description

The PF5300, PF5301 and PF5302 integrate high-performance buck converters, 12 A, 8 A, and 15 A, respectively, to power high-end automotive and industrial processors. With adaptive voltage positioning and a high bandwidth loop, they offer excellent transient regulation to minimize capacitor requirements.

Clock synchronization and spread-spectrum features reduce EMC issues in the system. The PF5300/PF5301/PF5302 can operate as stand-alone point-of-load regulator ICs or as companion chips to a larger PMIC.

2 Features and benefits

- Low Rdson Internal FETs
- 2.2 MHz switching frequency
- Dynamic Voltage Scaling
- Programmable AVP (droop)
- XFAILB interface for synchronization with NXP PF-PMICs
- Over temperature protection
- I2C Interface for monitoring and control
- Watchdog Timer

3 Applications

- Gateway
- Infotainment / Cluster / Driver Awareness
- Telematics
- V2X
- Radar
- Vision
- ADAS
- Sensor fusion



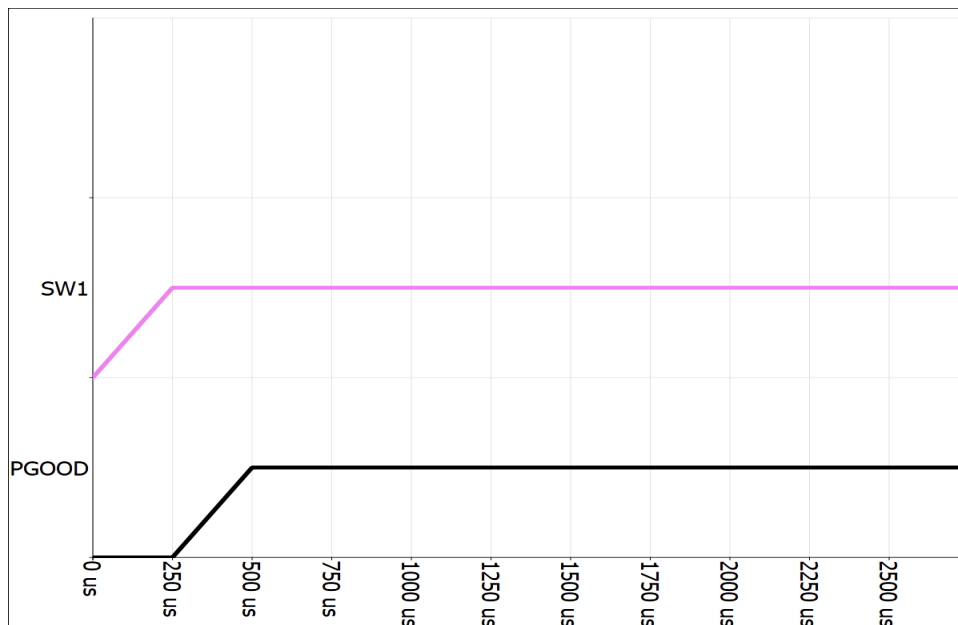
4 Ordering information

Table 1. Ordering information

Type number ^[1]	Package		
	Name	Description	Version
MPF53BDAMMA1ES	H-FC-PQFN-24	No leads, step-cut wettable flank, plastic thermal enhanced very thin quad flat pack; 24 terminals, 0.5 mm pitch, 4.5 mm x 3.5 mm x 0.75 mm body	SOT2090 - 1(SC)

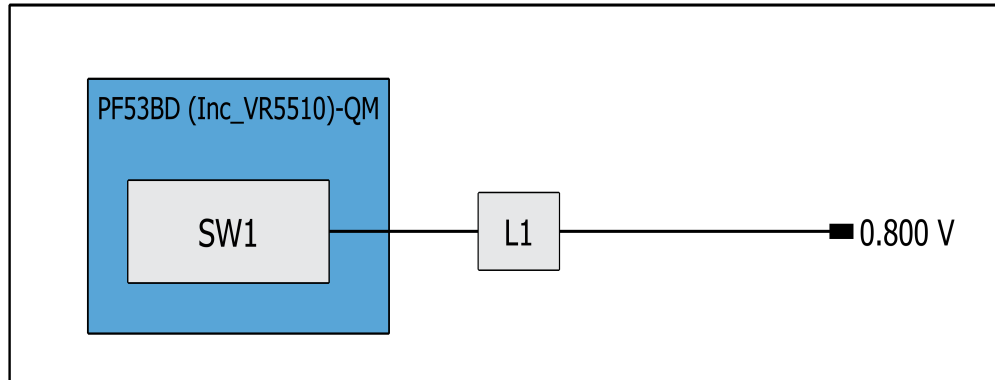
[1] To order parts in tape and reel, add the R2 suffix to the part number.

5 Power-up sequence summary



The signals depicted above are enable signals for each regulator. They don't represent the actual ramp voltage.

6 Hardware configuration diagram



7 OTP configuration

See PF5300 datasheet for parametric details. The OTP configuration summary for A1 sequence ID is provided in Tables below.

Table 2. Device OTP configuration

Functional block	Feature	OTP selection
System Configuration	I2C Address	0x28
	Maximum Fault Counter	15 Faults
I/O Configuration	ULP OFF Control	Goto ULPOFF at turn off
Clock Management	Nominal Switching Frequency	18 MHz
	SYNCIN Range	2000 KHz to 3000 KHz
	Frequency Spread Spectrum	Disabled
	FSS Select	Triangular Modulation
	SYNCIN Mode	STANDBY input
	SW1 PLL Enable	PLL is enabled

Configuration report for (Inc_VR5510)-QM OTP program ID: A1 rev A

Table 3. Power Sequencer configuration

Functional block	Feature	OTP selection
Power Up Sequence	Sequence Time Base	250 us
	SW1 Sequence Slot	Slot 0
	PGOOD Sequence Slot	Slot 1
	Turn Off Delay	0

Table 4. SW Regulator configuration

Functional block	Feature	OTP selection
SW1	SW1 Output Voltage	0.800 V
	SW1 Output Inductor	0
	SW1 Discharge Resistor	PD resistor discharged
	SW1 AVP	0 mV/A (disabled)
	SW1 Soft Start	4 mV/us
	SW1 AVP Filter	2010 kHz
	SW1 Run Mode	PWM Mode
	SW1 Diode Emulation	Disable diode emulation
	SW1 Diode Braking Threshold	5.0 mV
	SW1 HIZ OFF	High and low side FETs are turned off
	SW1 Discharge	4 mV/us
	SW1 DVS MAX	1.200 V
	SW1 DVS MIN	0.500 V

Configuration report for (Inc_VR5510)-QM OTP program ID: A1 rev A

SW1 Compensation	SW1 Gain Margin	68 us
	SW1 Compensation Resistor	174 kOhm
	SW1 Compensation Capacitor	25 pF
SW1 State	SW1 OV Bypass	No impact due to SW1 OV on fault counter
	SW1 UV Bypass	No impact due to SW1 UV on fault counter
	SW1 ILIM Bypass	No impact due to SW1 ILIM on fault counter

Table 5. Program ID

Functional block	Feature	OTP selection
Program ID	Program ID High	A
	Program ID Low	1

8 Legal information

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Date of release: 5/18/2023

Document identifier: R_MPF53BDAMMA1ES